

Specification

Drawing No.	EQM08-5OC-00AF773-00
Issued Date	Jun-20-2012

To Digi-Key

Note: In case of specification change, KYOCERA Part Number also will be changed.

Customer Part Number	
KYOCERA Part Number	KC2016Bxx.xxxC1GE00
Remarks: This product is Pb-Free Moisture Sensitivity Lev	•

Customer Acceptance

Please sign here and send one copy back to us.

Signature:

Accepted Date:

Seller

KYOCERA Corporation

6 Takeda Tobadono-cho, Fushimi-ku, Kyoto, Japan 612-8501 TEL: +81-75-604-3500 FAX: +81-75-604-3501

Manufacturer KYOCERA Crystal Device Corporation

1-8-1 Izumihon-cho, Komae, Tokyo, Japan 201-8648 TEL: +81-3-5497-3110 FAX: +81-3-5497-3208

Design Department	Quality	Approved by	Checked by	Issued by	
KYOCERA Crystal Device Corporation Nagano Okaya Plant	Assurance	Approved by	Onecked by	issued by	
Clock Oscillator Division Application Engineering Section	M. Morimoto	R. Mizutani	M. Matsumoto	T. Asakura	

Revision History

Rev. No.	Description of revise	Issued Date	Approved by	Checked by	lssued by
00	First Edition	Jun-20-2012	R. Mizutani	M. Matsumoto	T. Asakura

1. Scope

This specification shall be defined of the Clock Oscillator for the integrated circuits (ICs).

2. Customer Part Number

3. KYOCERA Part Number

KC2016Bxx.xxxxC1GE00

4. Electrical Characteristics

4-1. Absolute Maximum Rating

Item	Symbol Rated Value		Units
Power Supply Voltage	V _{CC}	-0.5 to +6.0	V
Input Voltage	V _{IN}	-0.5 to V _{CC} +0.5	V
Storage Temperature	T _{STG}	-55 to +125	С°

Note:

If the part is used beyond absolute maximum ratings, it may cause internal destruction. The part should be used under the recommended operating conditions the reliability of this part may be damaged if those conditions are exceeded.

4-2. Recommended Operating Conditions

Item	Symbol	Min	Тур	Max	Units	Remarks
Power Supply Voltage	V _{CC}	1.6	3.3	3.63	V	
Input Voltage	V _{IN}	0		Vcc	V	
Operating Temperature	T _{OPR}	-40	25	+85	С°	

4-3. Electrical Characteristics

Item	Symbol	Min	Тур	Max	Units	Remarks
Output Frequency	Fo	1.5		50	MHz	
Frequency Tolerance	F_ _{tol}	-50		+50	ppm	Include initial tolerance, operating temperature range, rated power supply voltage change, load change, aging (1year @25°C), shock and vibration
Current Consumption				2.5		1.5≤ f ₀ ≤24MHz
Current Consumption (Loaded/ 1.6≤Vcc≤2.0V)				3.5		24< f _o ≤40MHz
				4.5	-	40< f ₀ ≤50MHz
Current Consumption				3.0		1.5≤ f ₀ ≤24MHz
(Loaded/ 2.0 <v<sub>cc≤2.8V)</v<sub>	Icc			4.5		24< f ₀ ≤40MHz
				5.0		40< f ₀ ≤50MHz
Current Consumption				3.5		1.5≤ f ₀ ≤24MHz
Current Consumption (Loaded/ 2.8 <v<sub>CC≤3.63V)</v<sub>				5.0		24< f _o ≤40MHz
,				6.0		40< f ₀ ≤50MHz
Standby Current	I _{ST}			10	μA	
Symmetry (Duty Ratio)	SYM	45	50	55	%	@ 50% V _{CC}
Rise Time/ Fall Time				6.5		1.6≤V _{CC} ≤2.0V
(10% V_{cc} to 90% V_{cc})	Tr/ Tf			5.0	ns	2.0 <v<sub>CC≤2.8V</v<sub>
				4.5		2.8 <v<sub>CC≤3.63V</v<sub>
Output Voltage-"L"	V _{OL}			$10\% V_{CC}$	V	I _{OL} = 4mA
Output Voltage-"H"	V _{OH}	90% V _{CC}			v	I _{OH} =-4mA
Output Load	CL			15	pF	CMOS
Input Voltage-"L"	VIL			$30\% V_{CC}$	V	
Input Voltage-"H"	VIH	$70\% V_{CC}$			v	
Output Disable Time	t_ _{dis}			100	ns	
Output Enable Time	t_ _{ena}			5	ms	
Start-up Time	t_ _{sta}			10	ms	@Minimum operating voltage to be 0sec
1 Sigma Jitter*	J _{Sigma}			8	ps	
Peak to Peak Jitter*	J _{PK-PK}			80	μs	

Note: All electrical characteristics have defined on the maximum loaded and recommended operating conditions. * Based on Time Interval Analyzer "Wavecrest DTS-2079" with VISI 6.3.1.

Table 1



4-4. Measurement Condition

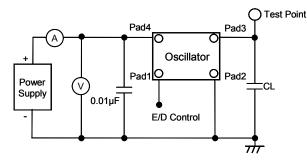
The reference temperature shall be 25±2°C. The measurement shall be performed at the temperature range of 5 °C to 35 °C unless otherwise the result is doubtful.

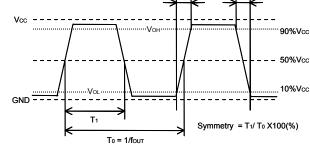
4-5. Measurement Circuit

The electrical characteristics shall be measured by test circuit "Fig. 1". Also jitter shall be measured by test circuit "Fig. 3".

4-6. Clock Timing Chart

The clock timing chart is "Fig. 2".





Note: CL includes probe and test fixture capacitance



Fig.2 Clock Timing Chart (C-MOS Output)

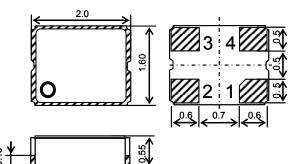
Clock Oscillator Test Fixture 50 ohm SMA Termination Pad3 WaveCrest DTS-2079 Oscillator ATT 6dB Pad1 Pad2 Pov Supply 10µF 0.01µF E/D Control 50 ohm COAX with SMA Connectors $\frac{1}{m}$

<Measurement Conditions>

- Time Interval Analyzer
- WaveCrest DTS-2079
- Jitter analysis software
- VISI 6.3.1
- DTS timer calibration ≻
 - Over 30minnites warm-up ⊳ Extend 30minites calibration
 - Jitter histogram conditions (Tail-fit)
 - More than 50,000cyc Hits
 - Bit Error Ratio (BER) -12 (14sigma)

Fig.3 Jitter Test Circuit

5. Dimensions and Marking

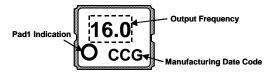


Pad1

OPEN

"H" Level

"L" Level



Output Frequency

The output frequency is four-digit including a decimal point. The frequency greater than the number of digits have rounded down. (E.g. 14.31818MHz → "14.3")

Manufacturing Date Code

Year	Code	Year	Code		Month	Code		Day	Code	Day	Code	Day	Code
2001	Α	2011	L		1	1		1	1	11	В	21	М
2002	В	2012	M		2	2		2	2	12	С	22	N
2003	С	2013	Ν		3	3		3	3	13	D	23	Р
2004	D	2014	Р		4	4		4	4	14	Е	24	Q
2005	Е	2015	Q		5	5		5	5	15	F	25	R
2006	F	2016	R		6	6		6	6	16	G	26	S
2007	G	2017	S		7	7		7	7	17	н	27	Т
2008	Н	2018	Т		8	8		8	8	18	J	28	V
2009	J	2019	V		9	9		9	9	19	к	29	W
2010	Κ	2020	W		10	Α		10	Α	20	L	30	Х
It repeats from A in 2021 and					11	В						31	Y
afterward	afterwards. 12 C												
e.g	e.g. :"C46" means "Apr-6-2003"												

Table 2



Plating Ni+Au

Tolerance: +/-0.1 Unit:(mm)

Pad3 (Output)

Active

Active High Z (No-Oscillation)

Enable/Disable Function

Pad arrangement

Case GND

Output

Vc

2

3

4

Enable/Disable

6. Parts Numbering Guide

$\frac{\text{KC2016B}}{A} \frac{\text{25.0000}}{B} \frac{\text{C}}{\text{C}} \frac{1}{D} \frac{\text{G}}{\text{E}} \frac{\text{E}}{\text{F}} \frac{\text{00}}{\text{G}}$

- A. Series (SMD Oscillator)
- B. Output Frequency (E.g. 25.0000MHz)
- C. Output
- C: C-MOS D. Supply Voltage
- 1: 1.8V/ 2.5V/ 3.3V Compatible E. Frequency Tolerance*
- G: ±50ppm

F. Symmetry (Duty Ratio) and Enable/Disable Function E: Symmetry: 45% to 55% with Stand-by Function
G. Suffix for Individual Requirements (STD Specification is "00")

Packing (Tape & Reel 2,000pcs/Reel)

*Over All Conditions:

Include initial tolerance, operating temperature range, rated power supply voltage change, load change, aging (1year @25°C), shock and vibration

7. Environmental Characteristics

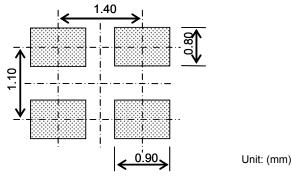
Items	Conditions	Criteria of Acceptance
7-1. Solderability	Soaking: 245±5°C, 5.0±0.5sec	Dipped potion: Minimum 95% coverage
7-2. Soldering Heat Resistance	Reflow soldering: Peak 260°C max, 10sec, Twice max Soldering iron: 380±5°C, 3+1/-0sec, Twice as one time for four pads	Without looseness or crack etc.
7-3. Temperature Cycle	10cycles: -55°C to +125°C (30minuts each/ cycle)	
7-4. Mechanical Shock (Pulse)	5 times 14,750m/sec ² (1,500G), Duration of pulse 0.5msec (MIL-STD-883D-2002.3 Condition B)	
7-5. Vibration	4 times each axis X, Y, Z: 20 to 2,000Hz and 2,000Hz to 20Hz/cycle Peak acceleration 196m/sec ² (20G) (MIL-STD-883D-2007.2 Condition A)	Clause 7-10 shall be satisfied.
7-6. High Temperature	1000 hours: Temperature: 85+5/-3°C	
7-7. Low Temperature	1000 hours: Temperature: -40+5/-3°C	
7-8. Humidity Cycle	10 cycles: Based on 1004 specifications (MIL-STD-883D-1004.7)	Clause 7-1 shall be satisfied.
7-9. Hermeticity 1 (Gross leak)	Soaking: 125°C, 5minutes	No bubbles appeared
7-10. Hermeticity 2 (Fine leak)	Measured by Helium Detector Equipment (MIL-STD-883D-1014.10 Condition A1)	5x10 ⁻⁹ Pa m ³ /sec max

After each testing, the parts shall be subjected to standard atmospheric conditions more than 2 hours. After that, the electrical characteristics shall be measured. The result of the test shall be satisfied **Table 1**.

Table 3



8. Recommended Land pattern and Soldering Guide



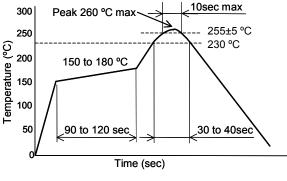
Note:

Since the part doesn't have Bypass Capacitor between V_{cc} and GND, Please mount high frequency type capacitor 0.01µF to the nearest position of oscillator.

Fig.4 Land pattern

8-1. Soldering Iron Conditions

- Numbers of soldering iron: •



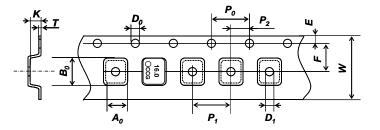
Available Reflow times: Maximum twice •

Fig.5 Reflow profile (Lead Free Available)

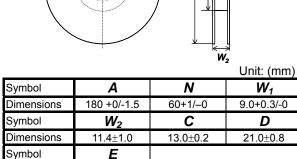
- Tip temperature of soldering iron: 380°C±5°C, Soldering time: 3sec+1/-0sec
 - Maximum twice as one time for 4 pads

Dimensions

9. Taping Specifications



				U	nit: (mm)		
Symbol	A ₀	B ₀	W	F	Ε		
Dimensions	1.8±0.1	2.25±0.1	8.0±0.2	3.5±0.05	1.75±0.1		
Symbol	P ₁	P ₂	P ₀	D ₀	Т		
Dimensions	4.0±0.1	2.0±0.05	4.0±0.1	1.5+0.1/-0	0.2±0.05		
Symbol	Κ	D ₁					
Dimensions	0.9±0.1	1.1±0.1					
Fig.6 Emboss Carrier Tape							



4

W₁

Fig.7 Reel

2.0±0.5

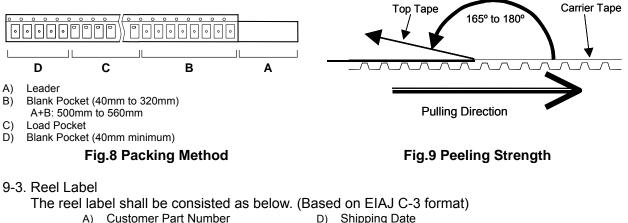
- 9-1. Taping Quantities
 - The taping of per reel shall be packed 2,000 pcs.
 - The parts shall be contained continuously in the pocket.

9-2. Leader and Blank Pockets

- The package shall be consisted of leader, blank pockets and loaded pocket as follows "Fig. 8".
- The power of peeling strength between top tape and carrier tape shall be 0.1N(10gf) to 0.7N(70gf) as follows "Fig. 9".



Drawing No. EQM08-5OC-00AF773-00 (5/5)



- B) Lot No.

- D) Shipping Date
- E) Vender Name

C) Quantities

9-4. Exterior Package Label

The oscillator shall be packed properly to avoid defect in transportation. The exterior package label shall be consisted as below.

- A) Name of Customer
 - B) P/O No.
 - **Customer Part Number** C)
 - D) Lot No.

- E) Quantities
- F) Shipping Date
- Vender Name G)

10. The agreement of this specifications

If the something suspicious is that part of the contents of this specification, it shall be resolved by mutual deliberations.

11. Remarks on Usages

A) Storage Conditions

The parts shall be stored in temperature range of -5 to +40°C, humidity 40 to 60% RH, and avoid direct sunlight. Then the parts shall be used within 6 months.

B) Handling Conditions

Although the part has protection circuit against static electricity, when excess static electricity is applied, the inside IC may get damaged.

Before mounting on the PCB, please make sure the direction of the part is correct. Otherwise the part of temperature will increase. And also the part will have some damages.

Please do not use the parts under the unfavorable condition such as beyond specified range in this specification.

Please do not use the parts under the condition, in the water or in the salt water also environment of dew or harmful gas.

- C) Soldering Conditions This product can respond to the general Pb-free reflow profile. The wave soldering can not be supported.
- D) Washing Conditions

Ultra sonic cleaning is available. However there is a possibility that Crystal in the part may cause damaged under certain condition. Therefore please test before using.

After washing, please dry the parts completely. Otherwise water drops between the parts and PCB may cause migration.

In case of using this part without above precaution, Kyocera is unable to guarantee the specific characteristics.

